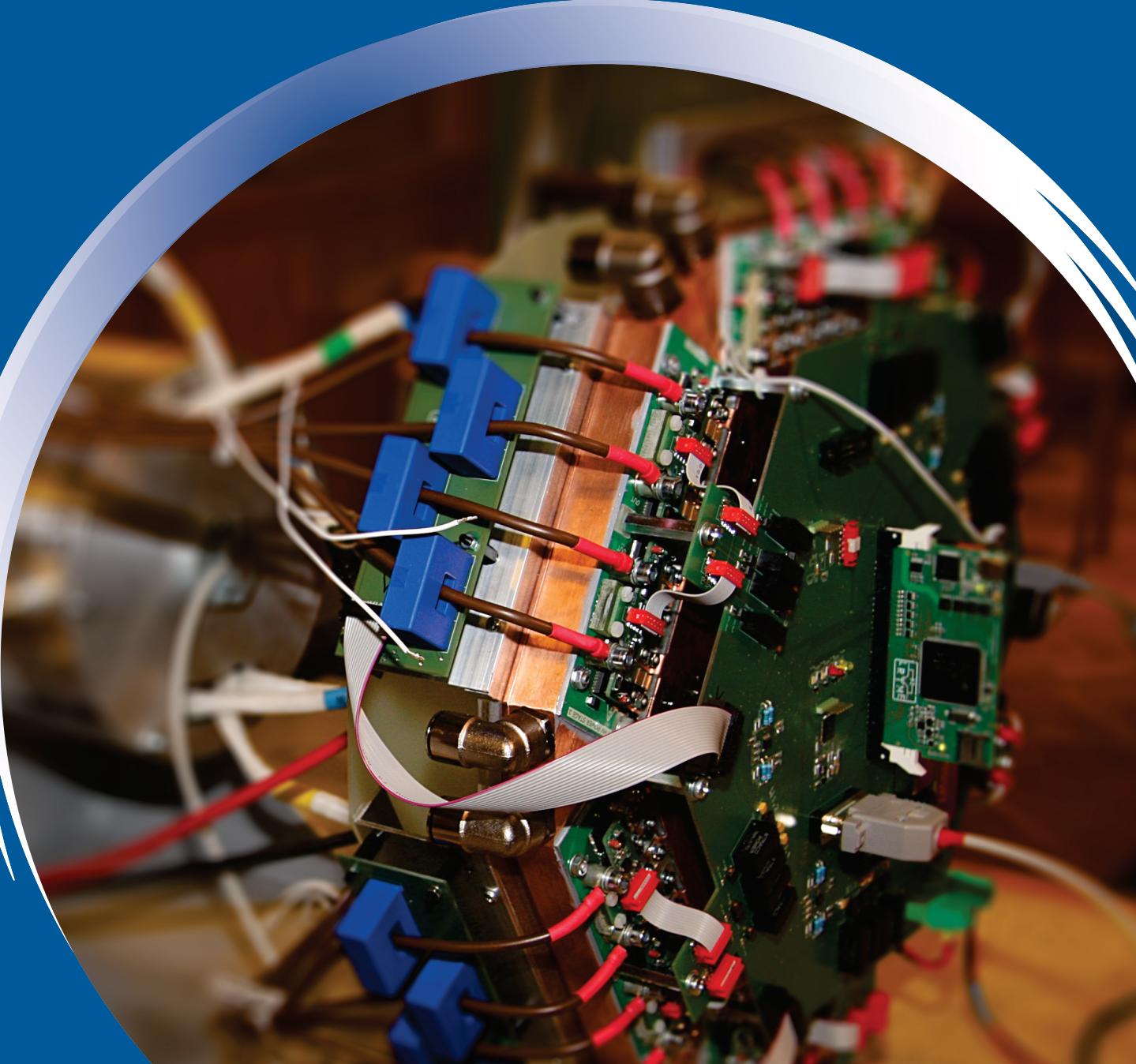


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MDEM pri MIKROIKS

Stegne 11, 1521 Ljubljana, Slovenia

T. +386 (0)1 513 37 68

F. + 386 (0)1 513 37 71

E. info@midem-drustvo.si

www.midem-drustvo.si

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Editorial | Uvodnik

Dear reader,

Isn't it amazing how time flies? Another covid-19 year is around, another year of restrictions and limitations both in private life as well as in professional life including science. For our journal it was quite a regular year. All operations and processes ran smoothly and I am grateful to EB members, reviewers and technical support team for their valuable contribution to the success. All papers published are open-access and accessible in WoS, Scopus, DOAJ or on the journal web pages by a single mouse click. Do open-access papers help us in wider dissemination and larger readership? We are tracking the numbers and the trends look promising.

In 2021 we received more than 141 manuscripts, out of which only 22 have been accepted for publication so far, while 25 were out of scope and 56 manuscripts were rejected. The success rate remains low (below 20% in 2021) primarily because we receive many manuscripts that do not meet the quality and scientific originality that we aim at. Citation metrics with JCR IF-2020=0.442, SNIP-2020=0.284 and CiteScore-2020=0.80 is an important performance indicator. In 2021 we published 2 review scientific papers (on microfluidics and on nanotechnology and nanoscience) and 22 original scientific papers.

We commit ourselves to continue serving you as a part of your success in science and engineering and look forward to receiving your future manuscript(s) on our submission page (<http://ojs.midem-drustvo.si/>).

Stay safe and healthy!

Prof. Marko Topič
Editor-in-Chief

23 March 2022

MIDEM 2022

57th INTERNATIONAL CONFERENCE ON MICROELECTRONICS, DEVICES AND MATERIALS WITH THE WORKSHOP ON ENERGY HARVESTING: MATERIALS AND APPLICATIONS

September 14th – September 16th, 2022
Hotel City, Maribor, Slovenia

Announcement and Call for Papers

Chairs:

Prof. Dr. Tadej Rojac
Assist. Prof. Dr. Mojca Otoničar

IMPORTANT DATES

Abstract submission deadline:

May 1, 2022

Acceptance notification:

June 15, 2022

Full paper submission deadline:

July 31, 2022

Invited and accepted papers will be published in the Conference Proceedings.

Detailed and updated information about the MIDEM Conferences, as well as for paper preparation can be found on

<http://www.midem-drustvo.si/>

GENERAL INFORMATION

The 57th International Conference on Microelectronics, Devices and Materials with the Workshop on Energy harvesting: materials and applications continues a successful tradition of the annual international conferences organised by the MIDEM Society, the Society for Microelectronics, Electronic Components and Materials. The conference will be held in **Hotel City, Maribor, Slovenia** from **SEPTEMBER 14th – 16th, 2022**.

Topics of interest include but are not limited to:

- Energy harvesting: modelling, materials, devices,
- Novel monolithic and hybrid circuit processing techniques,
- New device and circuit design,
- Process and device modelling,
- Semiconductor physics,
- Sensors and actuators,
- Electromechanical devices, microsystems and nanosystems,
- Nanoelectronics,
- Optoelectronics,
- Photovoltaic devices,
- Electronic materials science and technology,
- New electronic materials and applications,
- Materials characterization techniques,
- Reliability and failure analysis,
- Education in microelectronics, devices and materials.

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MIDEM Society - Society for Microelectronics, Electronic Components and Materials, Slovenia

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